

DATA SHEET

THIN FILM CHIP RESISTORS

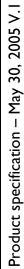
General purpose

RJ series (Pb Free) 1%, TC50

sizes 0201/0402/0603/0805/ 1206/1210/2010/2512



YAGEO







Chip Resistor Surface Mount

SERIES

0201 to 2512 (Pb Free)

SCOPE

This specification describes RJ0201 to RJ2512 general purpose chip resistors with lead-free terminations made by thin film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO ORDERING CODE

CTC CODE

RJ XXXX F X X XX XXX L (1) (2) (3) (4) (5) (6) (7)

(I) SIZE	
0201	
0402	
0603	
0805	
1206	
1210	
2010	
2512	

(2) TOLERANCE

 $F = \pm 1\%$

(3) PACKAGING TYPE

R = Paper/PE taping reel

K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

 $E = 50 \text{ ppm/}^{\circ}\text{C}$

(5) TAPING REEL

07 = 7 inch dia. Reel

10 = 10 inch dia. Reel (not preferred)

13 = 13 inch dia, Reel

(6) RESISTANCE VALUE

5R6, 56R, 560R, 5K6, 56K, IM.

(7) RESISTOR TERMINATIONS

L = Lead free terminations (matte tin) (a)

ORDERING EXAMPLE

The ordering code of a RJ0603 chip resistor, TC50 value 56 Ω with ±1% tolerance, supplied in 7-inch tape reel is: RJ0603FRE0756RL.

NOTE

- The "L" at the end of the code is only for ordering. On the reel label, the standard CTC will be mentioned an additional stamp "LFP"= lead free production.
- b. Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)





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MARKING

RJ0805 / RJ1206 / RJ1210 / RJ2010 / RJ2512



Either resistance in E-24 or E-96: 4 digits

First three digits for significant figure and 4th digit for number of zeros

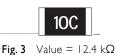
RJ0603



Fig. 2 Value = $12 \text{ k}\Omega$

E-24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros



E-96 series: 3 digits for 0603±1% EIA-96 marking method

RJ0201 / RJ0402



No marking

-Fig. 4

For marking codes, please see EIA-marking code rules in data sheet "Chip resistors marking".



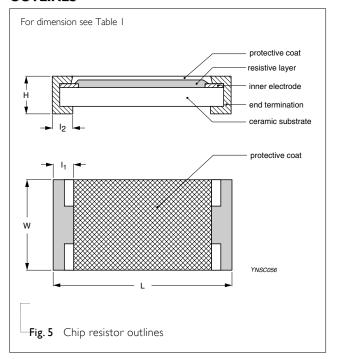
CONSTRUCTION

The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive layer. The resistive layer is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat and printed with the resistance value. Finally, the two external terminations (matte tin) are added. See fig. 5.

DIMENSION

Table	Table I For outlines see fig. 5							
TYPE	L (mm)	W (mm)	H (mm)	I _I (mm)	I ₂ (mm)			
RJ0201	0.6 ±0.10	0.30 ±0.05	0.25 ±0.05	0.15 ±0.10	0.15 ±0.10			
RJ0402	1.00 ±0.10	0.50 ±0.05	0.30 ±0.05	0.20 ±0.10	0.25 ±0.10			
RJ0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15			
RJ0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.35 ±0.20	0.35 ±0.20			
RJ1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.40 ±0.20			
RJ1210	3.10 ±0.10	2.60 ±0.15	0.55 ±0.10	0.50 ±0.20	0.50 ±0.20			
RJ2010	5.00 ±0.10	2.50 ±0.15	0.55 ±0.10	0.60 ±0.20	0.50 ±0.20			
RJ2512	6.35 ±0.10	3.20 ±0.15	0.55 ±0.10	0.60 ±0.20	0.50 ±0.20			

OUTLINES



ELECTRICAL CHARACTERISTICS

Table 2

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TYPE	RESISTANCE RANGE	OPERATING TEMPERATURE RANGE	DERATED TO 0 LOAD AT	MAXIMUM WORKING VOLTAGE	DIELECTRIC WITHSTAND VOLTAGE	MAXIMUM OVERTOAD VOLTAGE	TEMPERATURE COEFFICIENT OF RESISTANCE
RJ0201	10 Ω to 22 KΩ	-55 °C to +125 °C	+125 °C	15 V	50 V	50 V	±50 ppm/°C
RJ0402	I Ω to I2I K Ω	-55 °C to +125 °C	+125 °C	25 V	100 V	100 V	±50 ppm/°C
RJ0603	I Ω to 681 K Ω	-55 °C to +125 °C	+125 °C	50 V	100 V	100 V	±50 ppm/°C
RJ0805	I Ω to I.5 M Ω	-55 °C to +125 °C	+125 °C	100 V	250 V	200 V	±50 ppm/°C
RJ1206	I Ω to I.5 M Ω	-55 °C to +125 °C	+125 °C	150 V	250 V	250 V	±50 ppm/°C
RJ1210	I Ω to I $M\Omega$	-55 °C to +125 °C	+125 °C	150 V	400 V	300 V	±50 ppm/°C
RJ2010	I Ω to I $M\Omega$	-55 °C to +125 °C	+125 °C	150 V	400 V	300 V	±50 ppm/°C
RJ2512	I Ω to I $M\Omega$	-55 °C to +125 °C	+125 °C	150 V	400 V	300 V	±50 ppm/°C





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FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data" conformed to EU RoHS.

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	RJ0201	RJ0402	RJ0603	RJ0805	RJ1206	RJ1210	RJ2010	RJ2512
Paper/PE taping reel (R)	7" (178 mm)	10,000	10,000	5,000	5,000	5,000	5,000		
	10" (254 mm) ⁽²⁾	20,000	20,000	10,000	10,000	10,000	10,000		
	13" (330 mm)	50,000	50,000	20,000	20,000	20,000	20,000		
Embossed taping reel (K)	7" (178 mm)							4,000	4,000

NOTE

- 1. For Paper/PE/Embossed tape and reel specification/dimensions, please see the special data sheet "Packing" document.
- 2. 10" reel is not preferred typing reel.

FUNCTIONAL DESCRIPTION

OPERATINGTEMPERATURE RANGE

Range: -55°C to +125°C

POWER RATING

Each type rated power at 70°C: RJ0201=1/20 W, RJ0402=1/16 W, RJ0603=1/16 W, RJ0805=1/10 W, RJ1206=1/8 W, RJ1210=1/4 W, RJ2010=1/2 W, RJ2512=3/4 W.

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

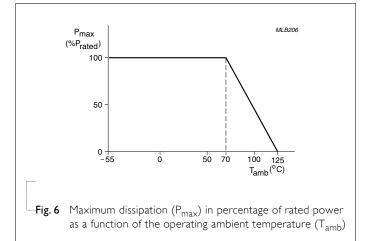
$$V = \sqrt{(P \times R)}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$





TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of	MIL-STD-202F-method 304; JIS C 5202-4.8	At +25/-55 °C and +25/+125 °C	±50 ppm/°C
Resistance		Formula:	
(T.C.R.)		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where	
		t_1 =+25 °C or specified room temperature	
		t_2 =–55 °C or +125 °C test temperature	
		R _I =resistance at reference temperature in ohms	
		R ₂ =resistance at test temperature in ohms	
Thermal Shock	MIL-STD-202F-method 107G; IEC 60115-1 4.19	At -65 (+0/-10) °C for 2 minutes and at +125 (+10/-0) °C for 2 minutes; 25 cycles	±(0.5%+0.05 Ω)
Low	MIL-R-55342D-Para 4.7.4	At –65 (+0/–5) °C for I hour, RCWV applied	±(0.5%+0.05 Ω)
Temperature		for 45 (+5/–0) minutes	No visible damage
Operation			
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	±(1.0%+0.05 Ω)
Overload	IEC 60115-1 4.13	temperature	No visible damage
Insulation	MIL-STD-202F-method 302;	RCOV for 1 minute	≥10 GΩ
Resistance	IEC 60115-1 4.6.1.1	Details see below table 5	
	MII CTD 2025	M :	
Dielectric Withstand	MIL-STD-202F-method 301; IEC 60115-1 4.6.1.1	Maximum voltage (V _{rms}) applied for I minute	No breakdown or flashover
Voltage	IEC 60113-1 4.6.1.1	Details see below table 5	
Resistance to	MIL-STD-202F-method 210C;	Unmounted chips; 260 ±5 °C for 10 ±1	±(0.5%+0.05 Ω)
Soldering	IEC 60115-1 4.18	seconds	No visible damage
Heat			C
Life	MIL-STD-202F-method I08A;	At 70±2 °C for 1,000 hours; RCWV applied for	±(1%+0.05 Ω)
	IEC 60115-1 4.25.1	1.5 hours on and 0.5 hour off	



Chip Resistor Surface Mount RJ SERIE

SERIES 0201 to 2512 (Pb Free)

Table 4 Test condition, procedure and requirements (continued)

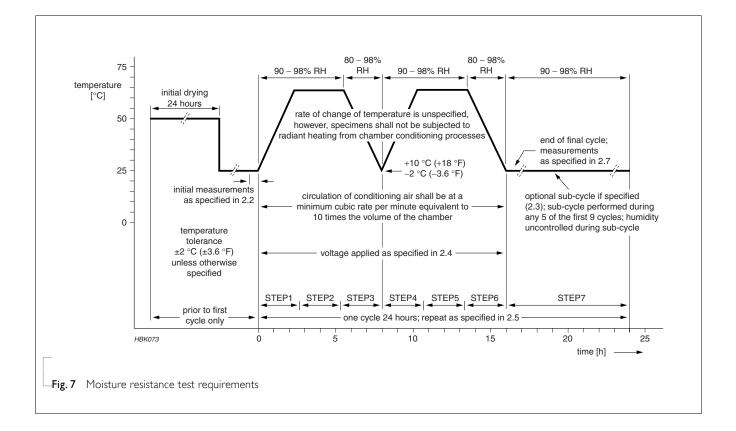
EST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability	MIL-STD-202F-method 208A;	Solder bath at 245±3 °C	Well tinned (≥95% covered)
	IEC 60115-1 4.17	Dipping time: 2±0.5 seconds	No visible damage
Bending	JIS C 5202.6.14;	Resistors mounted on a 90 mm glass epoxy resin	±(1.0%+0.05 Ω)
Strength	IEC 60115-1 4.15	PCB (FR4)	No visible damage
		Bending: see table 6 for each size	
Resistance to	MIL-STD-202F-method 215;	Isopropylalcohol (C ₃ H ₇ OH) or dichloromethane	No smeared
Solvent	IEC 60115-1 4.29	(CH ₂ Cl ₂) followed by brushing	
Noise	JIS C 5202 5.9;	Maximum voltage (V _{ms}) applied.	< 10 dB
	IEC 60115-1 4.12		
Humidity	JIS C 5202 7.5;	I,000 hours; 40±2 °C; 93(+2/-3)% RH	±(0.5%+0.05 Ω)
(steady state)	IEC 60115-8 4.24.8	RCWV applied for 1.5 hours on and 0.5 hour off	±(0.570 · 0.05 32)
Leaching	EIA/IS 4.13B;	Solder bath at 260±5 °C	No visible damage
	IEC 60115-8 4.18	Dipping time: 30±1 seconds	
Intermittent Overload	JIS C 5202 5.8	At room temperature; 2.5 × RCWV applied for I second on and 25 seconds off; total 10,000 cycles	±(1.0%+0.05 Ω)
Resistance to Vibration	On request	On request	
Moisture	MIL-STD-202F-method 106F;	42 cycles; total 1,000 hours	±(0.5%+0.05Ω)
Resistance Heat	IEC 60115-1 4.24.2	Shown as figure 7	No visible damage

Table 5 Criteria of rated continued working voltage and overload voltage

TYPE	RJ0201	RJ0402	RJ0603	RJ0805	RJ1206	RJ1210	RJ2010	RJ2512
Voltage (DC/unit: V); (AC/ unit: V _{rms})	50	100	100	300	500	500	500	500

Table 6 Bending for sizes 0201 to 2512

TYPE	RJ0201	RJ0402	RJ0603	RJ0805	RJ1206	RJ1210	RJ2010	RJ2512
Specification (mm)	2	2	3	3	2	2	2	2









REVISION HISTORY

YAGEO

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Nov 11, 2003		- First issue of this specification
Version I	May 30, 2005	-	- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)